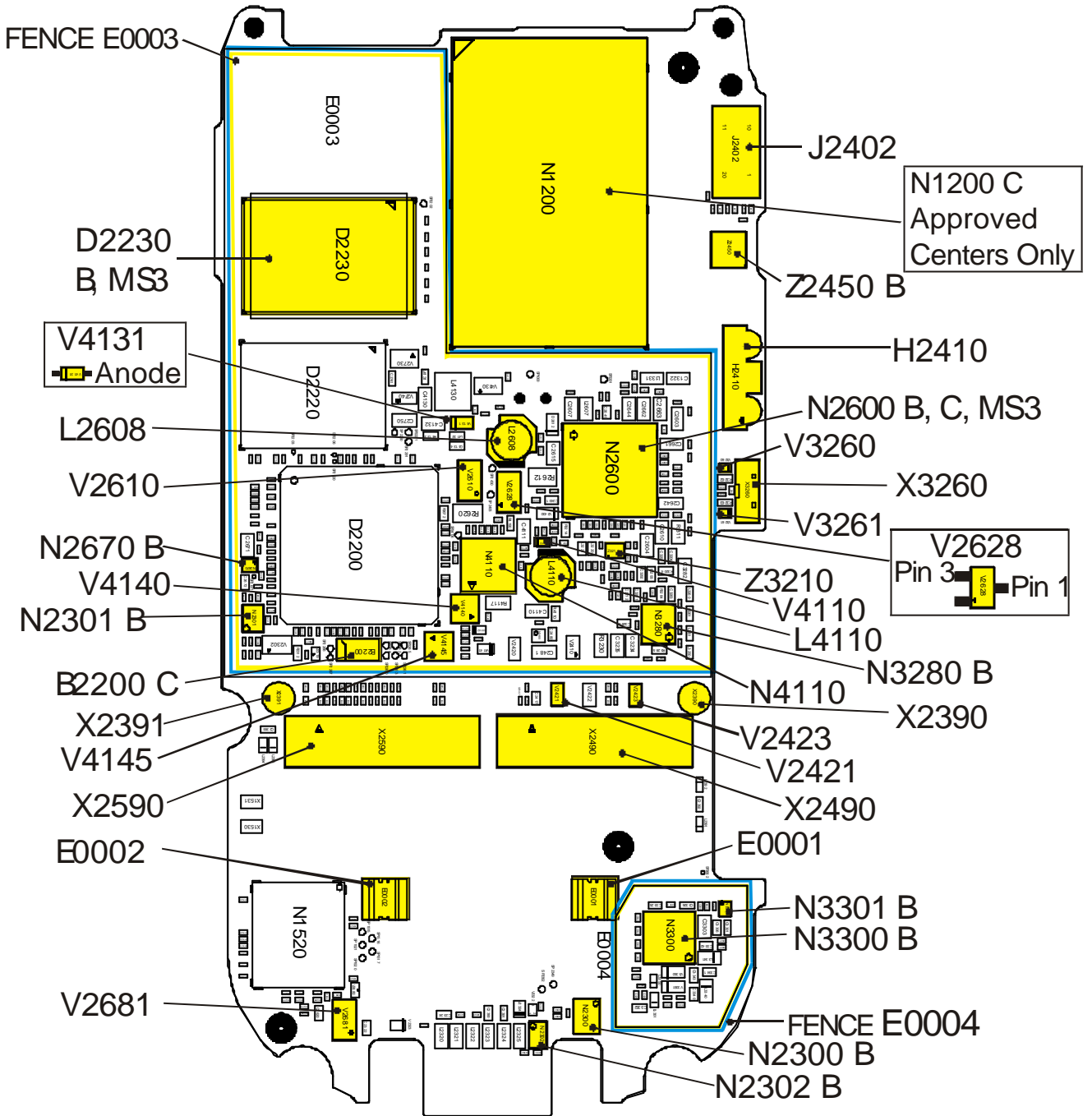




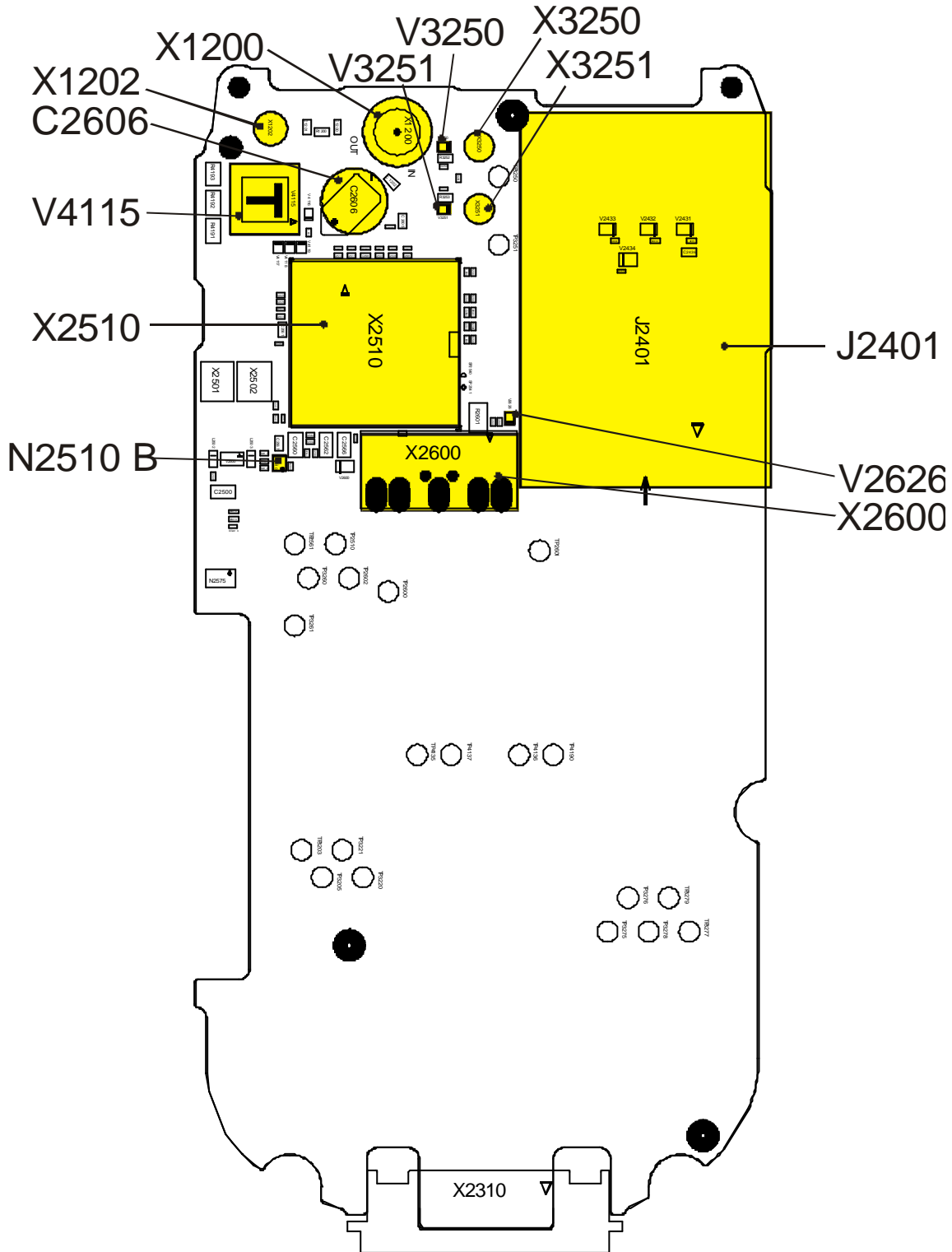
# 1 Component Placing (Primary Side)



**B - BGA Rework Equipment Required**  
**C - Calibration Required**  
**MS - Moisture Sensitive - Baking Required**



## 2 Component Placing (Secondary Side)



**B - BGA Rework Equipment Required**  
**C - Calibration Required**  
**MS - Moisture Sensitive - Baking Required**

TVK: Layer information  
 Layer 1: Signal  
 Layer 2: Signal  
 Layer 3: Signal and supply lines  
 Layer 4: GND main  
 Layer 5: Striplines, supply lines and signal which need careful routing  
 Layer 6: GND  
 Layer 7: Signal  
 Layer 8: Signal

